Octal Schmitt trigger buffer/line driver; 3-state; inverting Rev. 4 — 31 December 2012 Product data

Product data sheet

1. **General description**

The 74HC7540; 74HCT7540 is a high-speed Si-gate CMOS device and is pin compatible with Low-power Schottky TTL (LSTTL). It is specified in compliance with JEDEC standard No. 7A.

The 74HC7540; 74HCT7540 provides eight inverting buffer/line drivers with 3-state outputs and Schmitt-trigger action. The 3-state outputs are controlled by the output enable inputs OE1 and OE2. A HIGH on OEn causes the outputs to assume a high-impedance OFF-state. Schmitt trigger action on the data inputs transforms slowly changing input signals into sharply defined, jitter-free output signals.

The 74HC7540; 74HCT7540 is identical to the 74HC540; 74HCT540 but has hysteresis on the data inputs.

2. **Features and benefits**

- Inverting outputs
- Low-power dissipation
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

Ordering information 3.

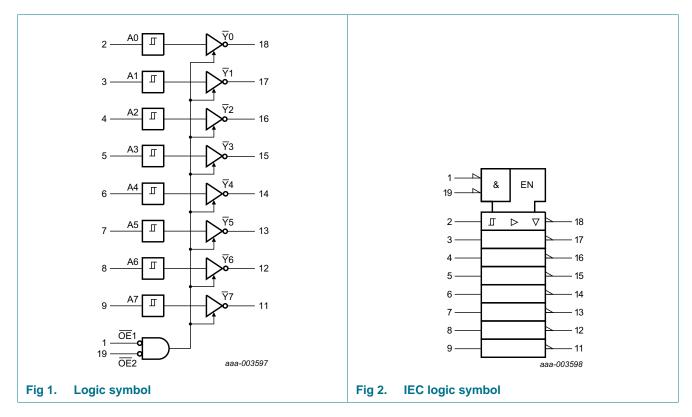
Table 1. **Ordering information**

Type number	Package	Package									
	Temperature range	Name	Description	Version							
74HC7540N	–40 °C to +125 °C	DIP20	plastic dual in-line package; 20 leads (300 mil)	SOT146-1							
74HCT7540N											
74HC7540D	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads;	SOT163-1							
74HCT7540D			body width 7.5 mm								
74HC7540DB	–40 °C to +125 °C	SSOP20	plastic shrink small outline package; 20 leads; body width 5.3 mm	SOT339-1							

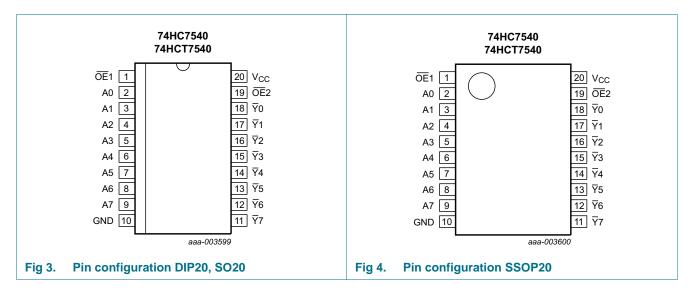


Octal Schmitt trigger buffer/line driver; 3-state; inverting

4. Functional diagram



5. Pinning information



5.1 Pinning

Octal Schmitt trigger buffer/line driver; 3-state; inverting

5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
OE1	1	output enable input (active LOW)
A0 to A7	2, 3, 4, 5, 6, 7, 8, 9	data input
GND	10	ground (0 V)
$\overline{Y}0$ to $\overline{Y}7$	18, 17, 16, 15, 14, 13, 12, 11	data output
OE2	19	output enable input (active LOW)
V _{CC}	20	supply voltage

6. Functional description

Table 3. Functional table^[1]

Control		Input	Output
OE1	OE2	An	Yn
L	L	L	Н
L	L	Н	L
Х	Н	Х	Z
Н	Х	Х	Z

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

7. Limiting values

Table 4.Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

nbol	Parameter	Conditions	Min	Max	Unit
>	supply voltage		-0.5	+7	V
	input clamping current	$V_{\rm I}$ < –0.5 V or $V_{\rm I}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
	output clamping current	$V_{\rm O}$ < –0.5 V or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5 V	<u>[1]</u> _	±20	mA
	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$	-	±35	mA
	supply current		-	70	mA
D	ground current		-70	-	mA
J	storage temperature		-65	+150	°C
	total power dissipation		[2]		
	DIP20		-	750	mW
	SO20, SSOP20		-	500	mW
	DIP20				

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For DIP20 packages: above 70 °C the value of P_{tot} derates linearly with 12 mW/K.

For SO20 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K. For SSOP20 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.

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8. Recommended operating conditions

Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions 74HC7540					74HCT7540				
			Min	Тур	Max	Min	Тур	Max			
V _{CC}	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V		
VI	input voltage		0	-	V _{CC}	0	-	V_{CC}	V		
Vo	output voltage		0	-	V_{CC}	0	-	V _{CC}	V		
T _{amb}	ambient temperature		-40	+25	+125	-40	+25	+125	°C		

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	T _{ar}	_{nb} = 25	°C		: –40 °C 85 °C	T _{amb} = −40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC75	40									
V _{OH}	HIGH-level	$V_I = V_{T+} \text{ or } V_{T-}$								
	output voltage	I_{O} = –20 $\mu A;$ V_{CC} = 2.0 V	1.9	2.0	-	1.9	-	1.9	-	V
		I_O = –20 $\mu A; V_{CC}$ = 4.5 V	4.4	4.5	-	4.4	-	4.4	-	V
		I_{O} = –20 $\mu A;$ V_{CC} = 6.0 V	5.9	6.0	-	5.9	-	5.9	-	V
		I_{O} = -6.0 mA; V_{CC} = 4.5 V	3.98	4.32	-	3.84	-	3.7	-	V
		I_{O} = -7.8 mA; V_{CC} = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V _{OL}	LOW-level	$V_I = V_{T+} \text{ or } V_{T-}$								
	output voltage	I_{O} = 20 $\mu A; V_{CC}$ = 2.0 V	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \ \mu\text{A}; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \ \mu A; V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		I_{O} = 6.0 mA; V_{CC} = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		I_{O} = 7.8 mA; V_{CC} = 6.0 V	-	0.16	0.26	-	0.33	-	0.4	V
II	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 6.0$ V	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{OZ}	OFF-state output current	per input pin; $V_I = V_{T+}$ or V_{T-} ; $V_O = V_{CC}$ or GND; other inputs at V_{CC} or GND; $V_{CC} = 6.0 \text{ V}$; $I_O = 0 \text{ A}$	-	-	±0.5	-	±5.0	-	±10	μΑ
I _{CC}	supply current		-	-	8.0	-	80	-	160	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT7	540									
V _{OH}	HIGH-level	V_{I} = V_{T+} or $V_{T-};V_{CC}$ = 4.5 V								
	output voltage	I _O = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -6.0 \text{ mA}$	3.98	4.32	-	3.84	-	3.7	-	V

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74HC7540; 74HCT7540

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Symbol	Parameter	Conditions	Tai	_{mb} = 25	°C	T _{amb} = –40 °C to +85 °C		T _{amb} = -40 °C to +125 °C		Unit
			Min	Тур	Мах	Min	Max	Min	Max	
V _{OL}	LOW-level	V_{I} = V_{T+} or $V_{T-};V_{CC}$ = 4.5 V								
	output voltage	I _O = 20 μA;	-	0	0.1	-	0.1	-	0.1	V
		l _O = 6.0 mA;	-	0.15	0.26	-	0.33	-	0.4	V
I _I	input leakage current	$V_{I} = V_{CC}$ or GND; $V_{CC} = 5.5$ V	-	-	±0.1	-	±1.0	-	±1.0	μA
I _{OZ}	OFF-state output current	per input pin; $V_I = V_{T+}$ or V_{T-} ; $V_O = V_{CC}$ or GND; other inputs at V_{CC} or GND; $V_{CC} = 5.5 \text{ V}$; $I_O = 0 \text{ A}$	-	-	±0.5	-	±5.0	-	±10	μΑ
I _{CC}	supply current		-	-	8.0	-	80	-	160	μA
ΔI_{CC}	additional supply current	per input pin; I _O = 0 A; V _I = V _{CC} - 2.1 V; other inputs at V _{CC} or GND; V _{CC} = 4.5 V to 5.5 V								
		An input	-	20	72	-	90	-	98	μA
		OEn input	-	130	468	-	585	-	637	μA
CI	input capacitance		-	3.5	-	-	-	-	-	pF

Table 6. Static characteristics ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

10. Dynamic characteristics

Table 7. Dynamic characteristics

 $GND = 0 V; C_L = 50 pF;$ for test circuit see <u>Figure 7</u>.

Symbol	Parameter	Conditions		Tar	_{nb} = 25	°C	T _{amb} = -40 °	°C to +125 °C	Unit
				Min	Тур	Мах	Max (85 °C)	Max (125 °C)	
74HC754	40						'		
t _{pd}	propagation delay	An to Yn; see Figure 5	[1]						
		$V_{CC} = 2.0 V$		-	39	120	150	180	ns
		$V_{CC} = 4.5 V$		-	14	24	30	36	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	11	-	-	-	ns
		$V_{CC} = 6.0 V$		-	11	20	26	31	ns
t _{en}	enable time	OEn to Yn; see Figure 6	[1]						
		$V_{CC} = 2.0 V$		-	41	150	190	225	ns
		$V_{CC} = 4.5 V$		-	15	30	38	45	ns
		$V_{CC} = 6.0 V$		-	12	26	33	38	ns
t _{dis}	disable time	OEn to Yn; see Figure 6	[1]						
		$V_{CC} = 2.0 V$		-	52	150	190	225	ns
		$V_{CC} = 4.5 V$		-	19	30	38	45	ns
		$V_{CC} = 6.0 V$		-	15	26	33	38	ns

Octal Schmitt trigger buffer/line driver; 3-state; inverting

Symbol	Parameter	Conditions	Conditions		_{nb} = 25	°C	T _{amb} = -40 °C to +125 °C		
				Min	Тур	Max	Max (85 °C)	Max (125 °C)	
t _t	transition time	see Figure 5	[2]				'		
		$V_{CC} = 2.0 V$		-	14	60	75	90	ns
		$V_{CC} = 4.5 V$		-	5	12	15	18	ns
		$V_{CC} = 6.0 V$		-	4	10	13	15	ns
C _{PD}	power dissipation capacitance	per package; V _I = GND to V _{CC}	[3]	-	29	-	-	-	pF
74HCT7	540								
t _{pd} p	propagation delay	An to Yn; see Figure 5	[1]						
		$V_{CC} = 4.5 V$		-	19	32	40	48	ns
		$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	16	-	-	-	ns
t _{en}	enable time	OEn to Yn; see Figure 6	[1]						
		$V_{CC} = 4.5 V$		-	19	32	40	48	ns
t _{dis}	disable time	OEn to Yn; see Figure 6	[1]						
		$V_{CC} = 4.5 V$		-	20	32	40	48	ns
t _t	transition time	V_{CC} = 4.5 V; see <u>Figure 5</u>	[2]	-	5	12	15	18	ns
C _{PD}	power dissipation capacitance	per package; V _I = GND to V _{CC} – 1.5 V	<u>[3]</u>	-	31	-	-	-	pF

Table 7.Dynamic characteristics

 $GND = 0 V; C_L = 50 pF;$ for test circuit see Figure 7.

t_{pd} is the same as t_{PLH} and t_{PHL}.
 t_{en} is the same as t_{PZL} and t_{PZH}.
 t_{dis} is the same as t_{PLZ} and t_{PHZ}.

[2] t_t is the same as t_{THL} and t_{TLH} .

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W): $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where: f_i = input frequency in MHz; f_o = output frequency in MHz;

 C_L = output load capacitance in pF;

 V_{CC} = supply voltage in V;

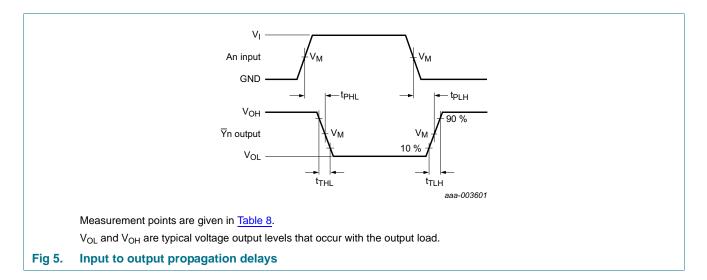
N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o) = \text{sum of outputs.}$

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11. Waveforms



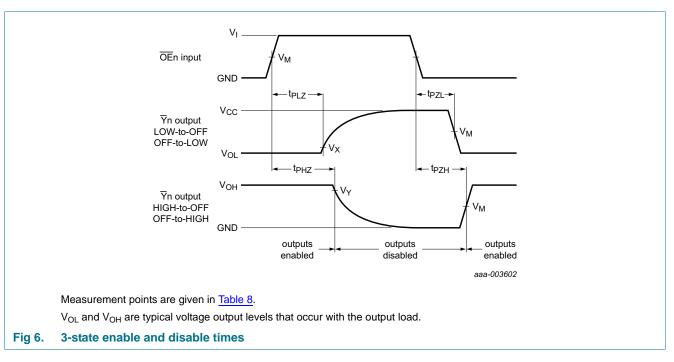


Table 8. Measurement points Type Input

Туре	Input	Output		
	V _M	V _M	V _X	V _Y
74HC7540	0.5V _{CC}	0.5V _{CC}	0.1V _{CC}	0.9V _{CC}
74HCT7540	1.3 V	1.3 V	0.1V _{CC}	0.9V _{CC}

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Octal Schmitt trigger buffer/line driver; 3-state; inverting

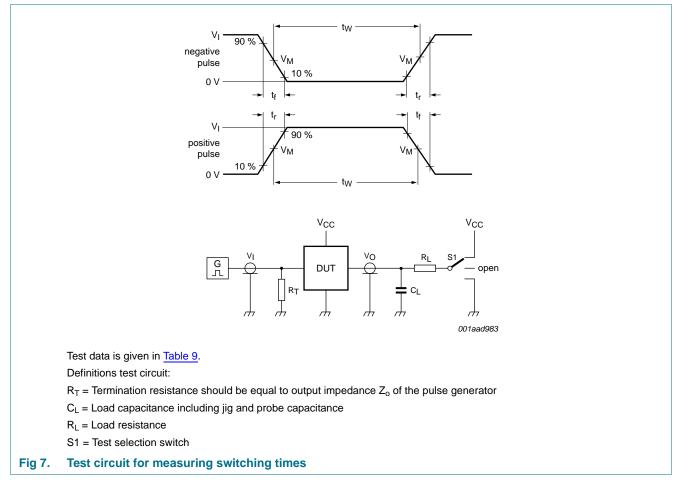


Table 9. Test data

Туре	Input		Load	Load		S1 position			
	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}		
74HC7540	V _{CC}	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}		
74HCT7540	3 V	6 ns	15 pF, 50 pF	1 kΩ	open	GND	V _{CC}		

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Product data sheet

Octal Schmitt trigger buffer/line driver; 3-state; inverting

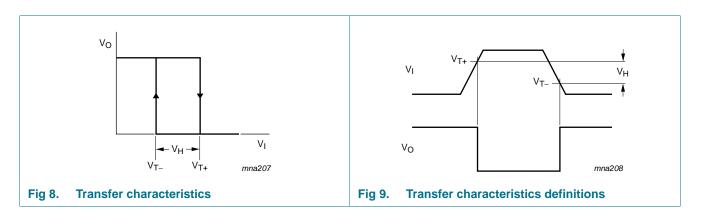
12. Transfer characteristics

Table 10. Transfer characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); see Figure 8 and Figure 9.

Symbol	Parameter	Conditions	T _{ar}	_{nb} = 25	°C		= –40 °C 85 °C	T _{amb} = −40 °C to +125 °C		Unit
			Min	Тур	Max	Min	Max	Min	Max	
74HC754	40		l							
V _{T+}	positive-going	$V_{CC} = 2.0 V$	-	-	1.5	-	1.5	-	1.5	V
	threshold	V_{CC} = 4.5 V	-	-	3.15	-	3.15	-	3.15	V
	voltage	$V_{CC} = 6.0 V$	-	-	4.2	-	4.2	-	4.2	V
V _{T-}	negative-going	$V_{CC} = 2.0 V$	0.3	-	-	0.3	-	0.3	-	V
	threshold voltage	V_{CC} = 4.5 V	1.35	-	-	1.35	-	1.35	-	V
		$V_{CC} = 6.0 V$	1.8	-	-	1.8	-	1.8	-	V
V _H	hysteresis	$V_{CC} = 2.0 V$	0.1	0.20	-	0.1	-	0.1	-	V
	voltage	$V_{CC} = 4.5 V$	0.25	0.40	-	0.25	-	0.25	-	V
		$V_{CC} = 6.0 V$	0.3	0.5	-	0.3	-	0.3	-	V
74HCT7	540									
V _{T+}	positive-going	$V_{CC} = 4.5 V$	-	-	2.0	-	2.0	-	2.0	V
	threshold voltage	V _{CC} = 5.5 V	-	-	2.1	-	2.1	-	2.1	V
V _{T-}	negative-going	$V_{CC} = 4.5 V$	0.7	-	-	0.64	-	0.6	-	V
	threshold voltage	$V_{CC} = 5.5 V$	0.8	-	-	0.74	-	0.7	-	V
V _H	hysteresis	$V_{CC} = 4.5 V$	0.17	0.23	-	-	-	-	-	V
	voltage	$V_{CC} = 5.5 V$	0.17	0.23	-	-	-	-	-	V

13. Transfer characteristics waveforms



74HC_HCT7540 Product data sheet

74HC7540; 74HCT7540

Octal Schmitt trigger buffer/line driver; 3-state; inverting

14. Package outline

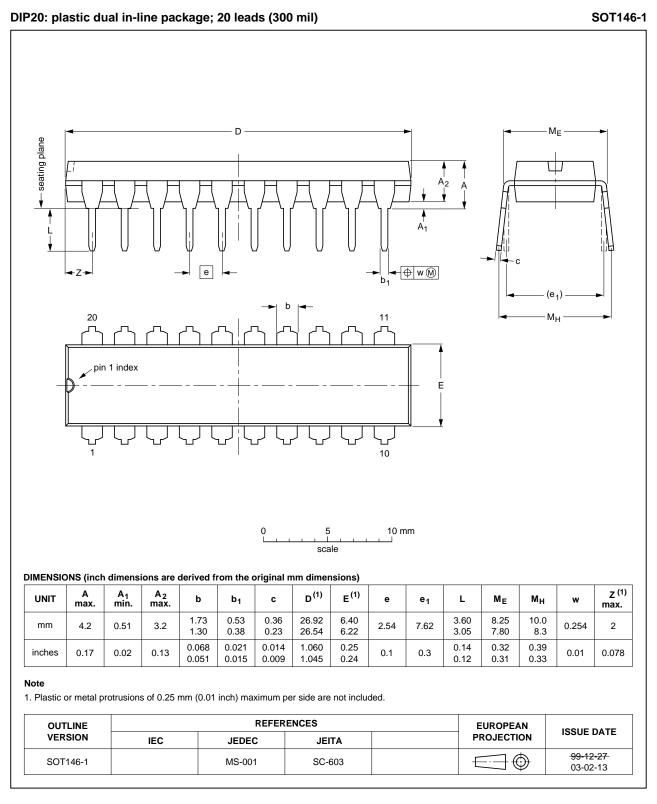


Fig 10. Package outline SOT146-1 (DIP20)

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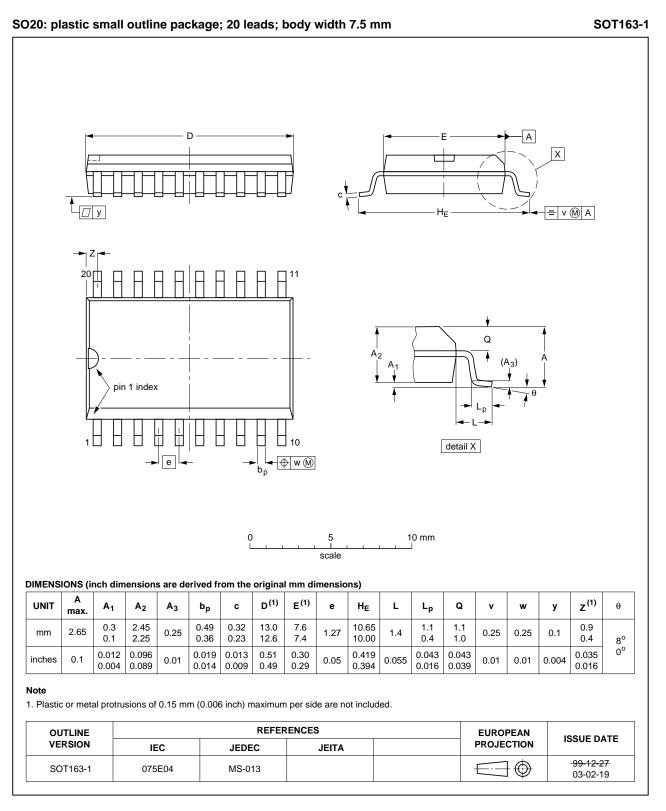


Fig 11. Package outline SOT163-1 (SO20)

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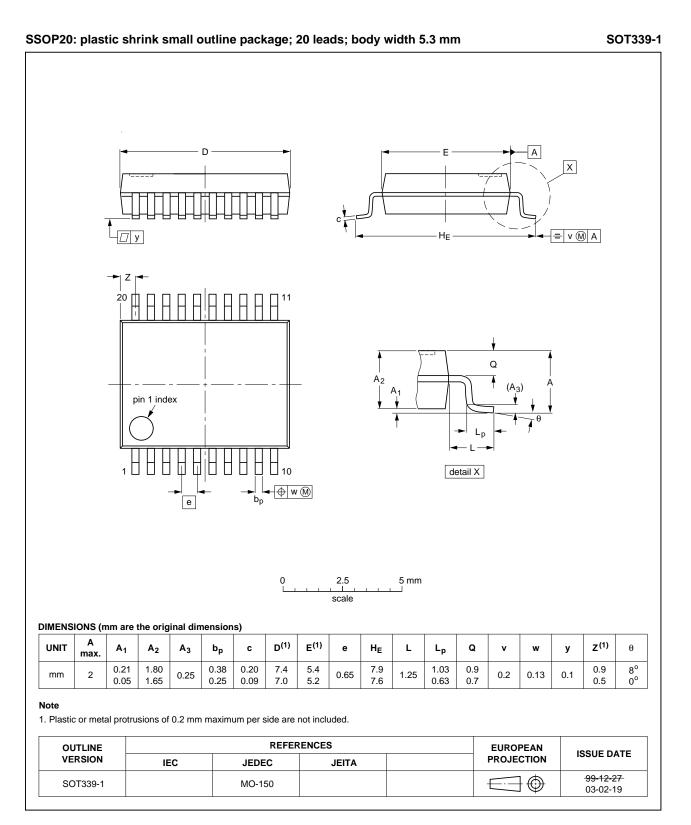


Fig 12. Package outline SOT339-1 (SSOP20)

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15. Abbreviations

Table 11. Abbreviations				
Acronym	Description			
CMOS	Complementary Metal-Oxide Semiconductor			
DUT	Device Under Test			
ESD	ElectroStatic Discharge			
HBM	Human Body Model			
LSTTL	Low-power Schottky Transistor-Transistor Logic			
MM	Machine Model			

16. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
74HC_HCT7540 v.4	20121231	Product data sheet	-	74HC_HCT7540 v.3	
Modifications:	 I_{OZ} added to 	static characteristics table.			
74HC_HCT7540 v.3	20120827	Product data sheet	-	74HC_HCT7540_CNV v.2	
Modifications:	 The format of this data sheet has been redesigned to comply with the new identity guidelines of NXP Semiconductors. 				
	 Legal texts h 	have been adapted to the new	company name whe	re appropriate.	
74HC_HCT7540_CNV v.2	19970917	Product specification	-	-	

Octal Schmitt trigger buffer/line driver; 3-state; inverting

17. Legal information

17.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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